Electronic Patent Application Fee Transmittal								
Application Number:	105	10522840						
Filing Date:	27-	27-Jan-2005						
Title of Invention:	Method and apparatus for injection foaming molding							
First Named Inventor/Applicant Name:	Tatsuya Tanaka							
Filer:	Marvin Jay Spivak/Shawn Berry							
Attorney Docket Number:	265044US0PCT							
Filed as Large Entity								
U.S. National Stage under 35 USC 371 Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:				,				
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Notice of appeal		1401	1	540	540			
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1110	1110
Miscellaneous:				
	Total in USD (\$)			1650